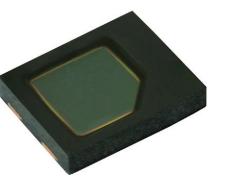
VEMD5060X01

Vishay Semiconductors





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DESCRIPTION

VEMD5060X01 is a high speed and high sensitive PIN photodiode with a highly linear photoresponse. It is a low profile surface mount device (SMD) including the chip with a 7.5 mm² sensitive area detecting visible and near infrared radiation.

FEATURES

- Package type: surface mount
- · Package form: top view
- Dimensions (L x W x H in mm): 5 x 4 x 0.9
- Radiant sensitive area (in mm²): 7.5
- AEC-Q101 qualified
- · High photo sensitivity
- · High radiant sensitivity
- Excellent I_{ra} linearity
- · Suitable for visible and near infrared radiation
- · Fast response times
- Angle of half sensitivity: $\varphi = \pm 65^{\circ}$
- Floor life: 72 h, MSL 4, according to J-STD-020
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- High speed photo detector
- Small signal detection
- Proximity sensors

PRODUCT SUMMARY				
COMPONENT	I _{ra} (μΑ)	φ (deg)	λ _{0.1} (nm)	
VEMD5060X01	26	± 65	350 to 1070	

Note

Test conditions see table "Basic Characteristics"

ORDERING INFORMATION					
ORDERING CODE	PACKAGING	REMARKS	PACKAGE FORM		
VEMD5060X01	Tape and reel	MOQ: 1000 pcs, 1000 pcs/reel	Top view		
VEMD5060X01-GS15	Tape and reel	MOQ: 5000 pcs, 5000 pcs/reel	Top view		

Note

MOQ: minimum order quantity

ABSOLUTE MAXIMUM RATINGS ($T_{amb} = 25 \degree C$, unless otherwise specified)				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Reverse voltage		V _R	20	V
Power dissipation	T _{amb} ≤ 25 °C	Pv	240	mW
Junction temperature		Тj	110	°C
Operating temperature range		T _{amb}	-40 to +110	°C
Storage temperature range		T _{stg}	-40 to +110	°C
Soldering temperature	According to reflow solder profile fig. 8	T _{sd}	260	°C
Thermal resistance junction / ambient	According to EIA / JESD51	R _{thJA}	350	K/W
ESD safety HBM	\pm 2000 V, 1.5 k $\Omega,$ 100 pF, 3 pulses	ESD _{HBM}	≥ 2	kV

1 For technical questions, contact: <u>detectortechsupport@vishay.com</u> Document Number: 84278

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BASIC CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Forward voltage	I _F = 50 mA	V _F	-	0.8	1.0	V
Breakdown voltage	I _R = 100 μA, E = 0	V _(BR)	20	-	-	V
Reverse dark current	V _R = 10 V, E = 0	I _{ro}	-	0.2	10	nA
Diode capacitance	$V_{R} = 0 V, f = 1 MHz, E = 0$	CD	-	80	-	pF
	V _R = 3 V, f = 1 MHz, E = 0	CD	-	35	40	pF
Open circuit voltage	$E_e = 1 \text{ mW/cm}^2$, $\lambda = 950 \text{ nm}$	Vo	-	350	-	mV
Temperature coefficient of Vo	$E_e = 1 \text{ mW/cm}^2$, $\lambda = 950 \text{ nm}$	TK _{Vo}	-	-2.6	-	mV/K
Short circuit current	$E_e = 1 \text{ mW/cm}^2$, $\lambda = 950 \text{ nm}$	l _k	-	26	-	μA
Temperature coefficient of I_k	$E_e = 1 \text{ mW/cm}^2$, $\lambda = 835 \text{ nm}$	TK _{lk}	-	0.1	-	%/K
Reverse light current	$E_e = 1 \text{ mW/cm}^2$, $\lambda = 950 \text{ nm}$, $V_R = 5 \text{ V}$	I _{ra}	20	26	31	μA
	$E_e = 1 \text{ mW/cm}^2$, $\lambda = 890 \text{ nm}$, $V_R = 5 \text{ V}$	I _{ra}	-	38	-	μA
Angle of half sensitivity		φ	-	± 65	-	deg
Wavelength of peak sensitivity		λ _p	-	820	-	nm
Range of spectral bandwidth		λ _{0.1}	-	350 to 1070	-	nm
Rise time	$V_R = 5 \text{ V}, \text{ R}_L = 50 \Omega, \lambda = 820 \text{ nm}$	t _r	-	30	-	ns
Fall time	$V_R = 5 \text{ V}, \text{ R}_L = 50 \Omega, \lambda = 820 \text{ nm}$	t _f	-	30	-	ns

BASIC CHARACTERISTICS (Tamb = 25 °C, unless otherwise specified)

Basic characteristics graphs to be extended to 110 °C ambient temperatures where applicable.

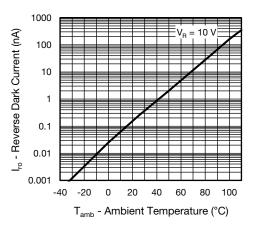


Fig. 1 - Reverse Dark Current vs. Ambient Temperature

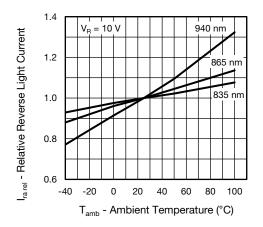
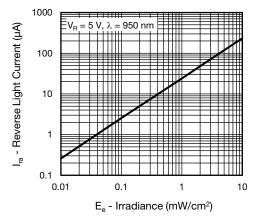


Fig. 2 - Relative Reverse Light Current vs. Ambient Temperature





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Fig. 3 - Reverse Light Current vs. Irradiance

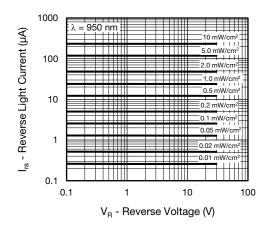


Fig. 4 - Reverse Light Current vs. Reverse Voltage

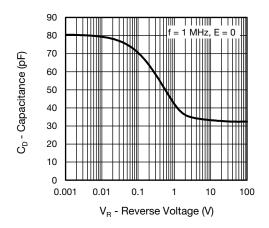


Fig. 5 - Diode Capacitance vs. Reverse Voltage

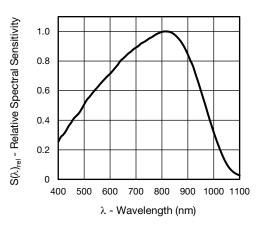


Fig. 6 - Relative Spectral Sensitivity vs. Wavelength

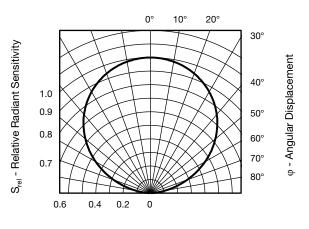
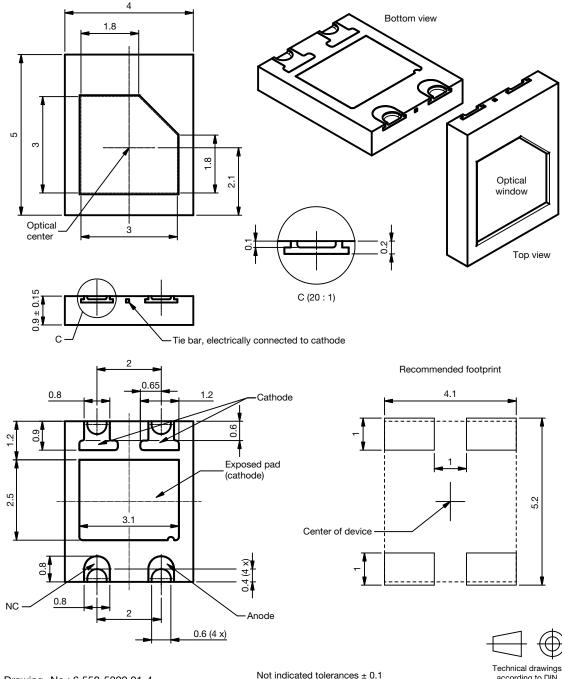


Fig. 7 - Relative Radiant Sensitivity vs. Angular Displacement

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PACKAGE DIMENSIONS in millimeters



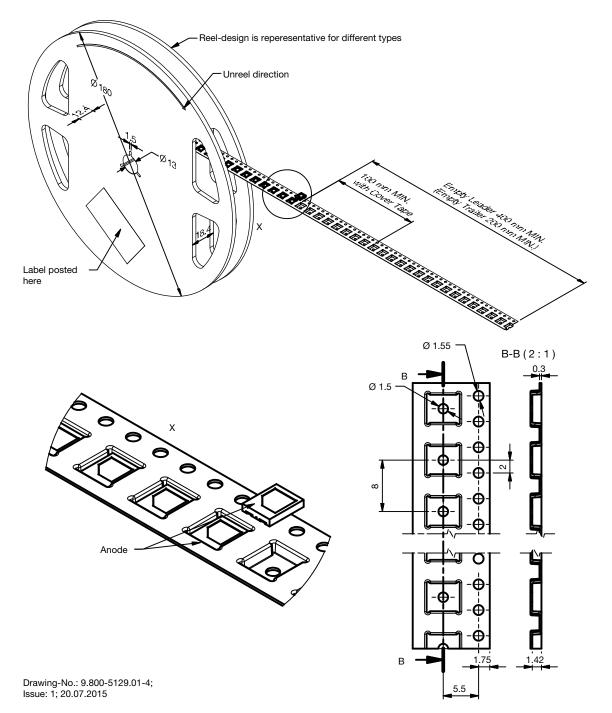
Drawing- No.: 6.550-5329.01-4 Issue: 2; 03.03.2016

Not indicated tolerances ± 0.1

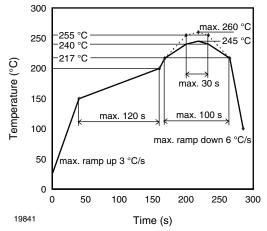




TAPE AND REEL DIMENSIONS in millimeters



SOLDER PROFILE



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Fig. 8 - Lead (Pb)-free Reflow Solder Profile According to J-STD-020D

DRYPACK

Devices are packed in moisture barrier bags (MBB) to prevent the products from moisture absorption during transportation and storage. Each bag contains a desiccant.

FLOOR LIFE

Time between soldering and removing from MBB must not exceed the time indicated in J-STD-020:

Moisture sensitivity: level 4

Floor life: 72 h

Conditions: $T_{amb} < 30$ °C, RH < 60 %

DRYING

In case of moisture absorption devices should be baked before soldering. Conditions see J-STD-020 or recommended conditions:

192 h at 40 °C (+ 5 °C), RH < 5 % or 96 h at 60 °C (+ 5 °C), RH < 5 %.



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